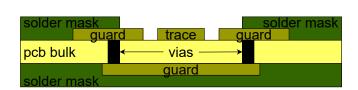


Appendix

Florian Rössing June 9, 2020

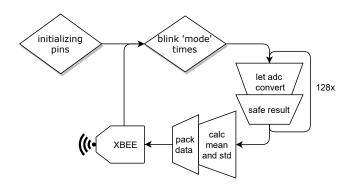


Guarding





Firmware Workflow I

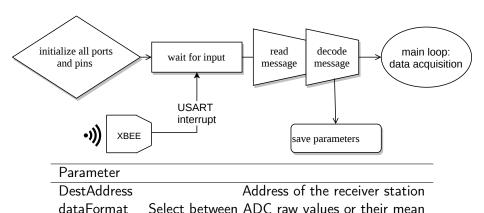




delay

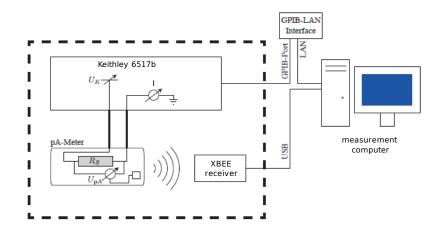
Firmware Workflow II

Adds a delay to adjust the readout rate



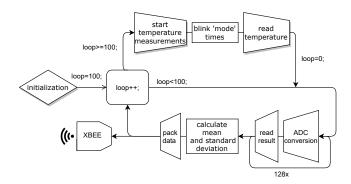


Calibration Setup





Firmware Workflow New



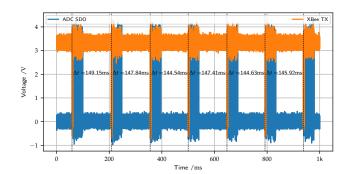


Temperature

| Component | Parameter | Fluctuation |
|-------------------|--------------------|---|
| | | in the range of 15 to 30 $^{\circ}\text{C}$ |
| ADA4530 [1] | Offset voltage | ±5 μV |
| | Input bias current | $\pm 0.1fA$ |
| LTC2327 [2] | Non-Linearity | ≤1 LSB |
| | Full-Scale Error | $\pm 2LSB$ |
| | Offset Error | ≪1LSB |
| Feedback resistor | Temperature Drift | 0.3 % |

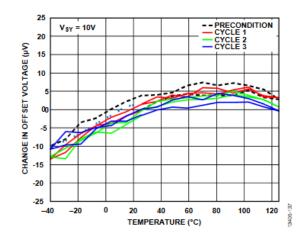


Prototype Duty-cycle



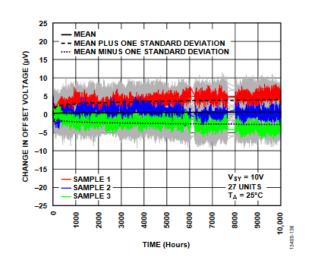


ADA4530 I





ADA4530 II



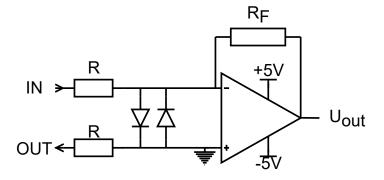


Cleaning

- 1. Ultrasonic cleaning in isopropyl alcohol for 30 min
- 2. flushing the board with isopropyl
- 3. use a brush scrub the solder joints
- 4. blow dry using compressed air
- 5. solder relays in place
- 6. repeat step 2, 3 & 4
- 7. bake the board at 80 °C for 3 h

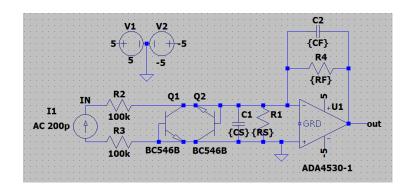


TIA OVP



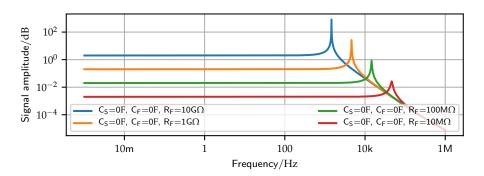


TIA Model



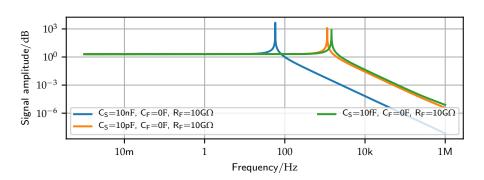


AC Simulation



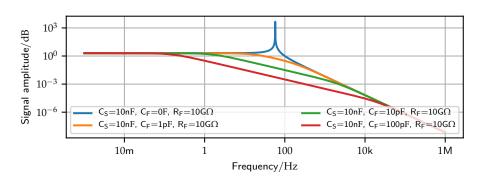


AC Simulation



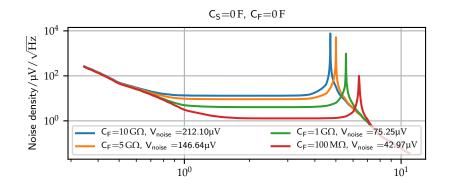


AC Simulation



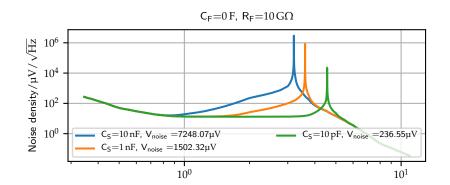


Noise Simulation



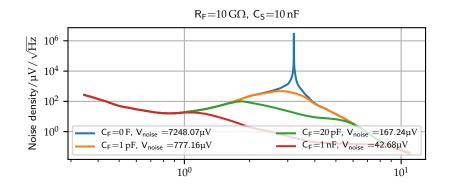


Noise Simulation



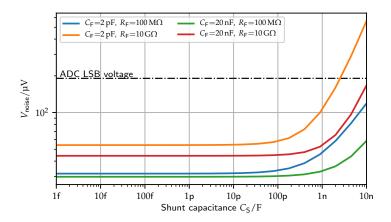


Noise Simulation



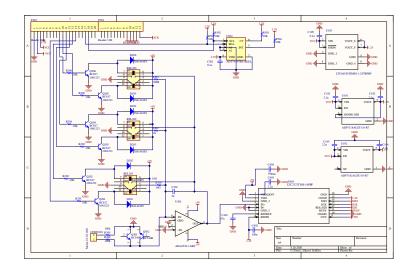


Noise



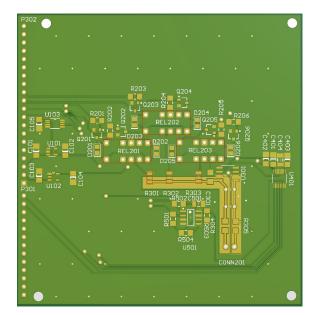


Prototype Front-End





Prototype Front-End





Bibliography



ADA4530 - Femtoampere Input Bias CurrentElectrometer Amplifier, b edition, 2017.



LTC2327-16 datasheet, b edition, 2017.